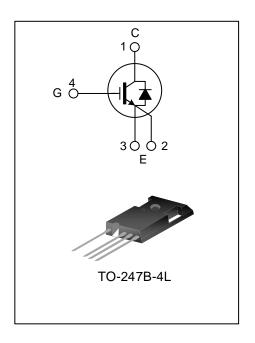
75A, 650V FIELD STOP IGBT

DESCRIPTION

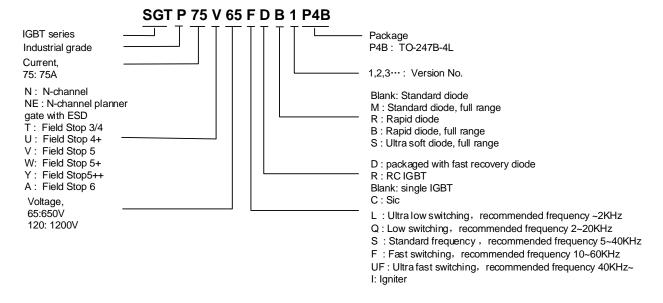
The SGTP75V65FDB1P4B field stop IGBT adopts Silan Field Stop 5 technology. It features low conduction loss and switching loss, is applicable to photovoltaic, UPS, SMPS and PFC fields.

FEATURES

- 75A, 650V, V_{CE(sat)(typ.)}=1.65V@I_C=75A
- Low conduction loss
- Fast switching
- High input impedance
- $T_{Jmax}=175^{\circ}C$



NOMENCLATURE



ORDERING INFORMATION

Part No.	Part No. Package Marking		Hazardous Substance Control	Packing Type
SGTP75V65FDB1P4B	TO-247B-4L	P75V65FDB1	Halogen free	Tube

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ABSOLUTE MAXIMUM RATINGS (T_C=25°C, UNLESS OTHERWISE NOTED)

Charac	teristics	Symbol	Ratings		
Collector-emitter Voltage V _{CE}		650	V		
Gate-emitter Voltag	е	V_{GE}	±20	V	
Transient Gate-emi (t _p ≤10µs, D<0.010)	tter Voltage	V_{GE}	±30	V	
Callagtar Current	T _C =25°C	I _C	150	Α	
Collector Current	Collector Current T _C =100°C		75	A	
Pulsed Collector Cu	ırrent	Ісм	300	Α	
Diode Forward	T _C =25°C	1	150	۸	
Current	T _C =100°C	l _F	75	A	
Diode Pulse Current		I _{FM}	300	Α	
Power Dissipation (T _C =25°C)		P _D	375	W	
Operating Junction	Temperature	TJ	-40~+175	°C	
Storage Temperatur	re Range	T _{stg}	-55~+150	°C	

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Unit		
Thermal Resistance, Junction to Case	D	0.4	°C/W		
(IGBT)	$R_{\theta JC}$	0.4			
Thermal Resistance, Junction to Case	В	0.4	0000		
(FRD)	$R_{\theta JC}$	0.4	°C/W		
Thermal Resistance, Junction to	В	40	0000		
Ambient (IGBT)	$R_{\theta JA}$	40	°C/W		

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ELECTRICAL CHARACTERISTICS OF IGBT (T_C=25°C, UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Collector- emitter Breakdown Voltage	BV _{CE}	V _{GE} =0V, I _C =250μA	650			V
Zero Gate Voltage Collector Current	I _{CES}	V _{CE} =650V, V _{GE} =0V			75	μΑ
Gate-emitter Leakage Current	I _{GES}	V _{GE} =20V, V _{CE} =0V			±100	nA
Gate-emitter Threshold Voltage	$V_{GE(th)}$	I _C =250uA, V _{CE} =V _{GE}	3.2	4.0	4.8	V
Collector-emitter Saturation Voltage	V	I _C =75A, V _{GE} =15V, T _C =25°C		1.65	2.2	V
Collector-enfilter Saturation voltage	V _{CE(sat)}	I _C =75A, V _{GE} =15V, T _C =125°C		1.95		V
Input Capacitance	Cies	V _{CE} =30V		4829		
Output Capacitance	Coes	V _{GE} =0V		132		pF
Reverse Transfer Capacitance	Cres	f=1MHz		21		
Turn-on Delay Time	T _{d(on)}			39		ns mJ
Rise Time	Tr	V _{CE} =400V		44		
Turn-off Delay Time	T _{d(off)}	I _C =75A		186		
Fall Time	T _f	$R_g=10\Omega$ $V_{GE}=15V$		38		
Turn-on Energy	Eon	Inductive load		2.39		
Turn-off Energy	E _{off}	T _C =25°C		0.90		
Total Switching Energy	E _{st}	10-23 0		3.29		
Turn-on Delay Time	T _{d(on)}	1/ 400\/		34		
Rise Time	Tr	V _{CE} =400V		26		20
Turn-off Delay Time	$T_{d(off)}$	I _C =37.5A		191		ns
Fall Time	T _f	$R_g=10\Omega$ $V_{GE}=15V$		39		
Turn-on Energy	E _{on}	Inductive load		0.65		
Turn-off Energy	E _{off}	T _C =25°C		0.35		mJ
Total Switching Energy	E _{st}			1.0		
Total Gate Charge	Qg			186		
Gate to Emitter Charge	Q _{ge}	V _{CE} =520V, I _C =75A, V _{GE} =15V		38		nC
Gate to Collector Charge	Q _{gc}			50		

ELECTRICAL CHARACTERISTICS OF FRD (T_C=25°C, UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Die de Fermand Voltage	V_{FM}	I _F =75A, T _C =25°C		1.55	1.9	V
Diode Forward Voltage		I _F =75A, T _C =150°C		1.45	1	
Diode Reverse Recovery Time	Trr	L75A dL-/dt-200A/ug		120	-	ns
Diode Reverse Recovery Charge	Q _{rr}	I _{ES} =75A, dI _{ES} /dt=200A/μs, T _C =25°C		0.4		μC
Diode Peak Reverse Recovery Current	Irrm	1c=25 C		6.3	1	Α

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ELECTRICAL CHARACTERISTICS OF IGBT (T_C=150°C)

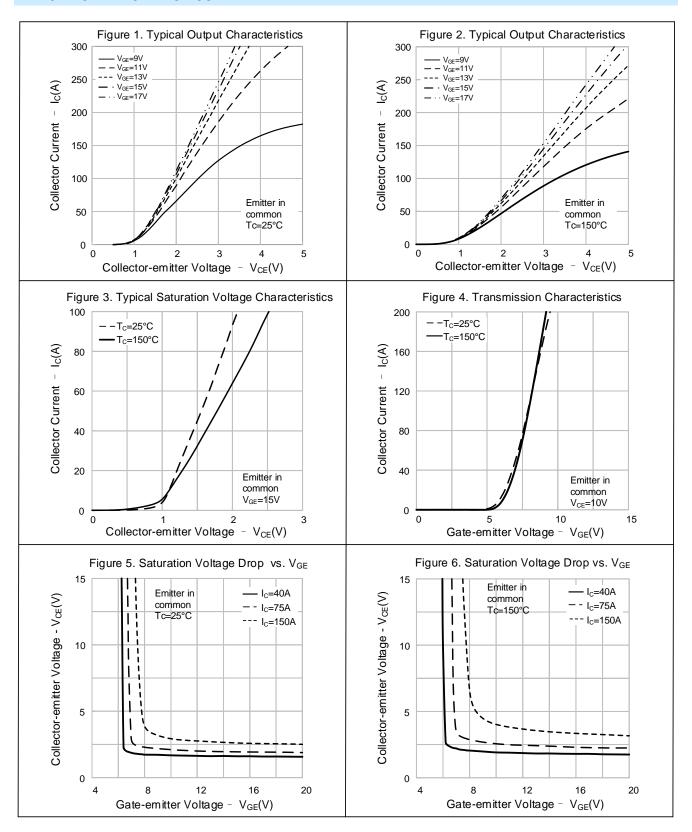
Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Turn-on Delay Time	T _{d(on)}	V 400V		51		
Rise Time	Tr	$V_{CE}=400V$		38		ns
Turn-off Delay Time	$T_{d(off)}$	I _C =75A		217		115
Fall Time	T _f	$R_g=10\Omega$		22		
Turn-on Energy	E _{on}	V _{GE} =15V Inductive load		2.67		
Turn-off Energy	E _{off}			1.52		mJ
Total Switching Energy	E _{st}	T _C =150°C		4.19		
Turn-on Delay Time	T _{d(on)}	V 400V		47		
Rise Time	Tr	V_{CE} =400V I_{C} =37.5A — R_{g} =10 Ω — V_{GE} =15V — Inductive load — T_{C} =150°C		20		20
Turn-off Delay Time	T _{d(off)}			235		ns
Fall Time	T _f			20		
Turn-on Energy	Eon			0.62		
Turn-off Energy	E _{off}			0.70		mJ
Total Switching Energy	E _{st}	10-100 0		1.32		

ELECTRICAL CHARACTERISTICS OF FRD(T_C=150°C)

Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Reverse Recovery	T _{rr}	I _{ES} =75A, dI _{ES} /dt=200A/μs, T _C =150°C		141	1	ns
Time						
Diode Reverse Recovery				2.8	1	μC
Charge						
Diode Peak Reverse				17		۸
Recovery Current	Irrm			17		Α

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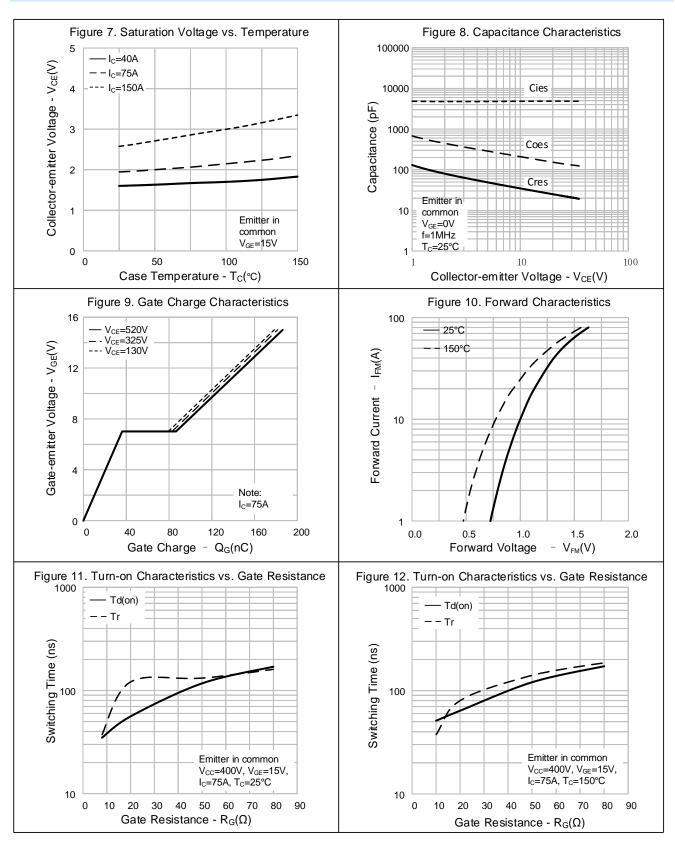
TYPICAL CHARACTERISTICS



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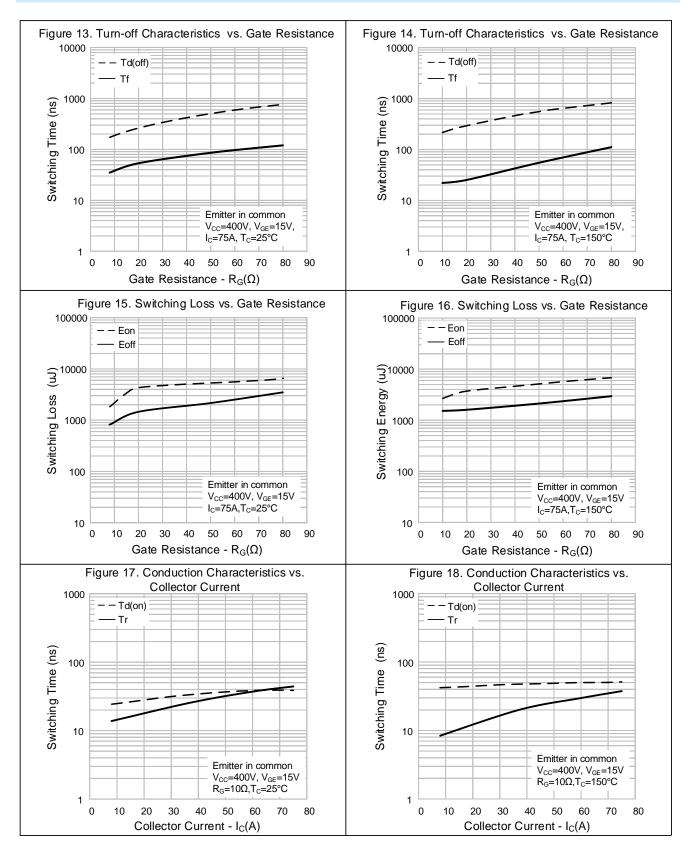


TYPICAL CHARACTERISTICS (CONTINUED)



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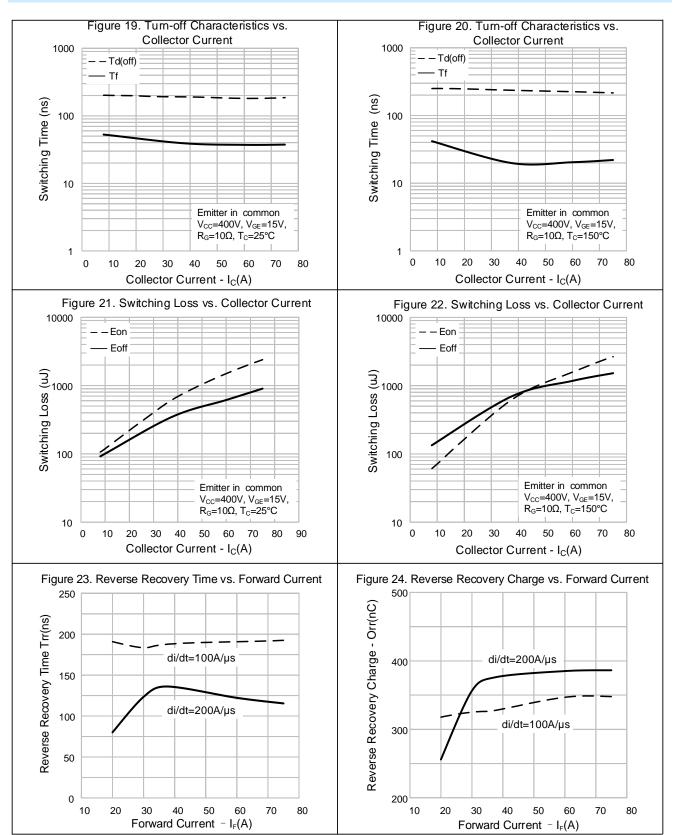
TYPICAL CHARACTERISTICS (CONTINUED)



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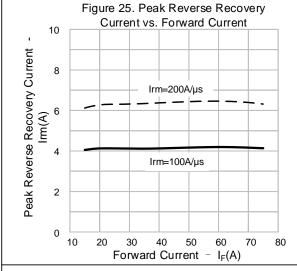
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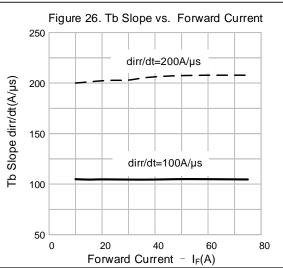


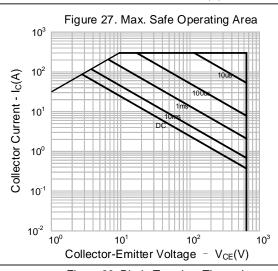
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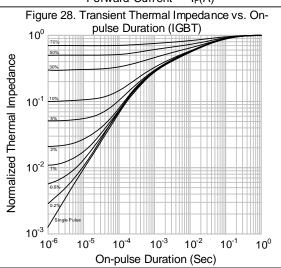


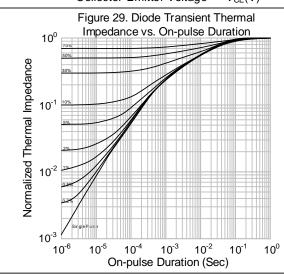
TYPICAL CHARACTERISTICS (CONTINUED)







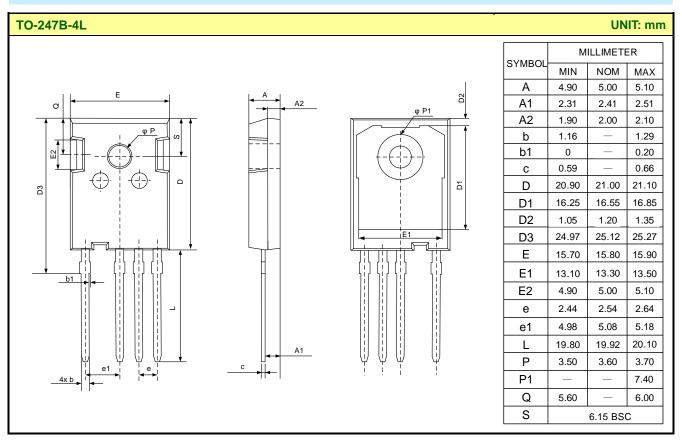




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PACKAGE OUTLINE





IGBT DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the IGBT electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- IGBT devices should be packed in antistatic/conductive containers for transportation.

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Important notice:

- 1. Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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- Please use and apply product in compliance with all applicable laws and regulations, including but not limited to trade control regulations etc. The product is civil electronic product, please do not use it in non-civil fields.
- 8. Product promotion is endless, our company will wholeheartedly provide customers with better products!
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Rev.: 1.0 Revision History:

1. First release

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